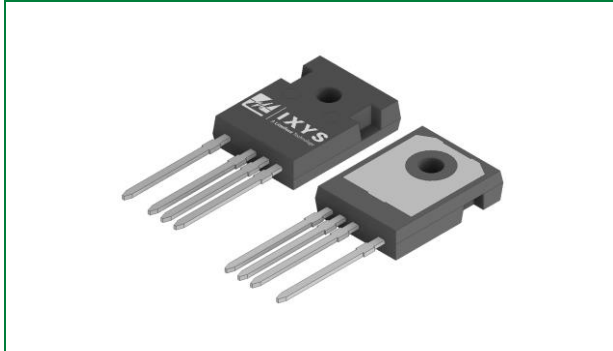


## LSIC1MO120G0160 1200 V, 160 mOhm N-Channel SiC MOSFET

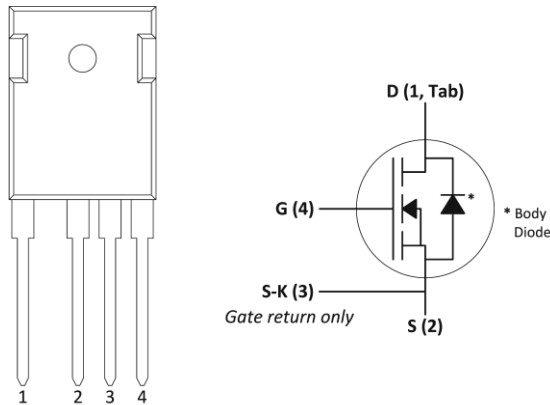


### Agency Approvals and Environmental

Environmental Approvals



### Circuit Diagram



### Product Summary

| Characteristic                                   | Value | Unit |
|--------------------------------------------------|-------|------|
| $V_{DS}$                                         | 1200  | V    |
| Typical $R_{DS(ON)}$                             | 160   | mOhm |
| $I_D$ ( $T_C \leq 100\text{ }^{\circ}\text{C}$ ) | 14    | A    |

### Features

- Optimized for high-frequency, high-efficiency applications
- Extremely low gate charge and output capacitance
- Low gate resistance for high-frequency switching
- Normally-off operations at all temperatures
- Ultra-low on-resistance
- Optimized package with separate driver source pin
- RoHS compliant, lead-free, and halogen-free

### Applications

- High-frequency applications
- Solar Inverters
- Switch Mode Power Supplies
- UPS
- Motor Drives
- High Voltage DC/DC Converters
- Battery Chargers
- Induction Heating

1. Maximum Ratings.....3

2. Thermal Characteristics .....3

3. Electrical Characteristics.....3

    3.1. Static Characteristics ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified).....3

    3.2. Dynamic Characteristics ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified) .....4

4. Reverse Diode Characteristics ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified) .....4

5. Performance Curves .....5

6. Package Dimensions .....9

7. Part Numbering and Marking.....9

8. Packing Options.....9

9. Packing Specifications .....10

## 1. Maximum Ratings

| Characteristic                    | Symbol                      | Conditions                                                        | Value       | Unit             |
|-----------------------------------|-----------------------------|-------------------------------------------------------------------|-------------|------------------|
| Drain-Source Voltage              | $V_{DS}$                    | $V_{GS} = 0\text{ V}$                                             | 1200        | V                |
| Continuous Drain Current          | $I_D$                       | $V_{GS} = 20\text{ V}, T_C = 25\text{ }^\circ\text{C}$            | 22          | A                |
|                                   |                             | $V_{GS} = 20\text{ V}, T_C = 100\text{ }^\circ\text{C}$           | 14          |                  |
| Pulsed Drain Current <sup>1</sup> | $I_{D(pulse)}$              | $T_C = 25\text{ }^\circ\text{C}$                                  | 45          | A                |
| Power Dissipation                 | $P_D$                       | $T_C = 25\text{ }^\circ\text{C}, T_J = 175\text{ }^\circ\text{C}$ | 125         | W                |
| Gate-Source Voltage               | $V_{GS,MAX}$                | Absolute maximum values – Steady state                            | -6 to +22   | V                |
|                                   | $V_{GS,OP,TR}$ <sup>2</sup> | Transient, $t_{transient} < 300\text{ nsec}$                      | -10 to +25  |                  |
|                                   | $V_{GS,OP}$ <sup>3</sup>    | Recommended DC operating values                                   | -5 to +20   |                  |
| Operating Junction Temperature    | $T_J$                       | -                                                                 | -55 to +175 | $^\circ\text{C}$ |
| Storage Temperature               | $T_{STG}$                   | -                                                                 | -55 to +150 | $^\circ\text{C}$ |
| Lead Temperature for Soldering    | $T_{sld}$                   | -                                                                 | 260         | $^\circ\text{C}$ |
| Mounting Torque                   | $M_D$                       | M3 or 6-32 screw                                                  | 1.0         | Nm               |
|                                   |                             |                                                                   | 8.8         | in-lb            |

Footnote 1: Pulse width limited by  $T_{J,MAX}$

Footnote 2: See Figure 21 for further information

Footnote 3: MOSFET can operate with  $V_{GS(OFF)} = 0\text{ V}$ .  $V_{GS(OFF)} = -5\text{ V}$  provides added noise margin and faster turn-off speed

## 2. Thermal Characteristics

| Characteristic                                  | Symbol          | Value | Unit               |
|-------------------------------------------------|-----------------|-------|--------------------|
| Maximum Thermal Resistance, junction-to-case    | $R_{th,JC,MAX}$ | 1.2   | $^\circ\text{C/W}$ |
| Maximum Thermal Resistance, junction-to-ambient | $R_{th,JA,MAX}$ | 40    | $^\circ\text{C/W}$ |

## 3. Electrical Characteristics

### 3.1. Static Characteristics ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)

| Characteristic                   | Symbol        | Conditions                                                                     | Value |      |     | Unit          |
|----------------------------------|---------------|--------------------------------------------------------------------------------|-------|------|-----|---------------|
|                                  |               |                                                                                | Min   | Typ  | Max |               |
| Drain-Source Breakdown Voltage   | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$                            | 1200  | -    | -   | V             |
| Zero Gate Voltage Drain Current  | $I_{DSS}$     | $V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$                                  | -     | <1   | 100 | $\mu\text{A}$ |
|                                  |               | $V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^\circ\text{C}$ | -     | <1   | -   |               |
| Gate Leakage Current             | $I_{GSS,F}$   | $V_{GS} = 22\text{ V}, V_{DS} = 0\text{ V}$                                    | -     | -    | 100 | nA            |
|                                  | $I_{GSS,R}$   | $V_{GS} = -6\text{ V}, V_{DS} = 0\text{ V}$                                    | -     | -    | 100 |               |
| Drain-Source On-State Resistance | $R_{DS(ON)}$  | $I_D = 10\text{ A}, V_{GS} = 20\text{ V}$                                      | -     | 160  | 200 | m $\Omega$    |
|                                  |               | $I_D = 10\text{ A}, V_{GS} = 20\text{ V}, T_J = 175\text{ }^\circ\text{C}$     | -     | 230  | -   |               |
| Gate Threshold Voltage           | $V_{GS(TH)}$  | $V_{DS} = V_{GS}, I_D = 5\text{ mA}$                                           | 1.8   | 2.8  | 4.0 | V             |
|                                  |               | $V_{DS} = V_{GS}, I_D = 5\text{ mA}, T_J = 175\text{ }^\circ\text{C}$          | -     | 1.8  | -   |               |
| Gate Resistance                  | $R_G$         | Resonance method, Drain-Source shorted <sup>1</sup>                            | -     | 0.85 | -   | $\Omega$      |

Footnote 1: For a description of the resonance method for measuring  $R_G$ , refer to the JEDEC Standard JESD24-11 test method

### 3.2. Dynamic Characteristics ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| Characteristic                   | Symbol       | Conditions                                                                                                                                                                     | Value |     |     | Unit          |
|----------------------------------|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-----|-----|---------------|
|                                  |              |                                                                                                                                                                                | Min   | Typ | Max |               |
| Turn-On Switching Energy         | $E_{ON}$     | $V_{DD} = 800\text{ V}$ , $I_D = 10\text{ A}$ ,<br>$V_{GS} = -5 / +20\text{ V}$ ,<br>$R_{G,ext} = 5\text{ }\Omega$ , $L = 1.4\text{ mH}$ ,<br>FWD = LSIC2SD120A05              | -     | 74  | -   | $\mu\text{J}$ |
| Turn-Off Switching Energy        | $E_{OFF}$    |                                                                                                                                                                                | -     | 32  | -   |               |
| Total Per-Cycle Switching Energy | $E_{TS}$     |                                                                                                                                                                                | -     | 106 | -   |               |
| Input Capacitance                | $C_{ISS}$    | $V_{DD} = 800\text{ V}$ , $V_{GS} = 0\text{ V}$ ,<br>$f = 1\text{ MHz}$ , $V_{AC} = 25\text{ mV}$                                                                              | -     | 890 | -   | $\text{pF}$   |
| Output Capacitance               | $C_{OSS}$    |                                                                                                                                                                                | -     | 45  | -   |               |
| Reverse Transfer Capacitance     | $C_{RSS}$    |                                                                                                                                                                                | -     | 5   | -   |               |
| COSS Stored Energy               | $E_{OSS}$    |                                                                                                                                                                                | -     | 14  | -   | $\mu\text{J}$ |
| Total Gate Charge                | $Q_g$        | $V_{DD} = 800\text{ V}$ , $I_D = 10\text{ A}$ ,<br>$V_{GS} = -5 / +20\text{ V}$                                                                                                | -     | 50  | -   | $\text{nC}$   |
| Gate-Source Charge               | $Q_{gs}$     |                                                                                                                                                                                | -     | 15  | -   |               |
| Gate-Drain Charge                | $Q_{gd}$     |                                                                                                                                                                                | -     | 17  | -   |               |
| Turn-On Delay Time               | $t_{d(on)}$  | $V_{DD} = 800\text{ V}$ , $I_D = 10\text{ A}$ ,<br>$V_{GS} = -5 / +20\text{ V}$ ,<br>$R_{G,ext} = 5\text{ }\Omega$ , $R_L = 80\text{ }\Omega$ ,<br>Timing relative to $V_{DS}$ | -     | 11  | -   | $\text{ns}$   |
| Rise Time                        | $t_r$        |                                                                                                                                                                                | -     | 7   | -   |               |
| Turn-Off Delay Time              | $t_{d(off)}$ |                                                                                                                                                                                | -     | 17  | -   |               |
| Fall Time                        | $t_f$        |                                                                                                                                                                                | -     | 9   | -   |               |

### 4. Reverse Diode Characteristics ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| Characteristic                          | Symbol   | Conditions                                                                                            | Value |     |     | Unit        |
|-----------------------------------------|----------|-------------------------------------------------------------------------------------------------------|-------|-----|-----|-------------|
|                                         |          |                                                                                                       | Min   | Typ | Max |             |
| Diode Forward Voltage                   | $V_{SD}$ | $I_S = 5\text{ A}$ , $V_{GS} = -5\text{ V}$                                                           | -     | 4.2 | -   | $\text{V}$  |
|                                         |          | $I_S = 5\text{ A}$ , $V_{GS} = -5\text{ V}$ , $T_J = 175\text{ }^{\circ}\text{C}$                     | -     | 3.7 | -   |             |
| Continuous Diode Forward Current        | $I_S$    | $V_{GS} = -5\text{ V}$ , $T_C = 25\text{ }^{\circ}\text{C}$                                           | -     | -   | 24  | $\text{A}$  |
| Peak Diode Forward Current <sup>1</sup> | $I_{SP}$ |                                                                                                       | -     | -   | 45  |             |
| Reverse Recovery Time                   | $t_{rr}$ | $V_{GS} = -5\text{ V}$ , $I_S = 10\text{ A}$ ,<br>$V_R = 800\text{ V}$ ,<br>$dI/dt = 6.2\text{ A/ns}$ | -     | 9   | -   | $\text{ns}$ |
| Reverse Recovery Charge                 | $Q_{rr}$ |                                                                                                       | -     | 140 | -   | $\text{nC}$ |
| Peak Reverse Recovery Current           | $I_{rm}$ |                                                                                                       | -     | 25  | -   | $\text{A}$  |

Footnote 1: Pulse width limited by  $T_{J,MAX}$

## 5. Performance Curves

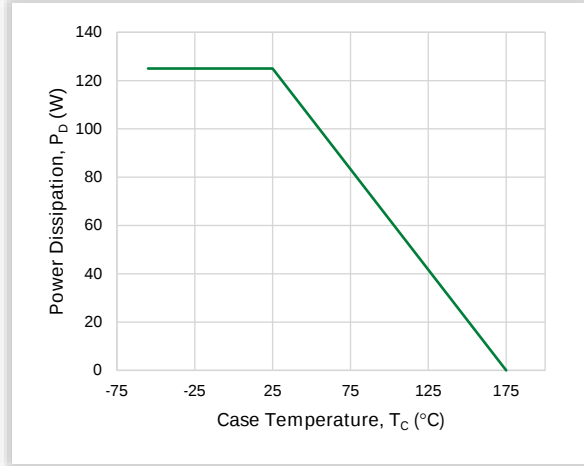
Figure 1. Maximum Power Dissipation ( $T_J = 175^\circ\text{C}$ )

Figure 2. Typical Transfer Characteristics

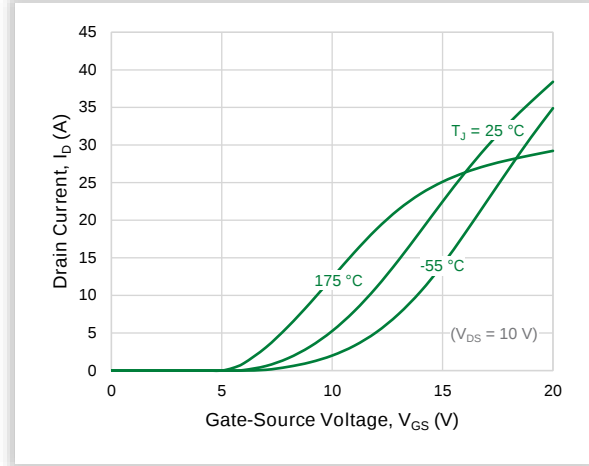
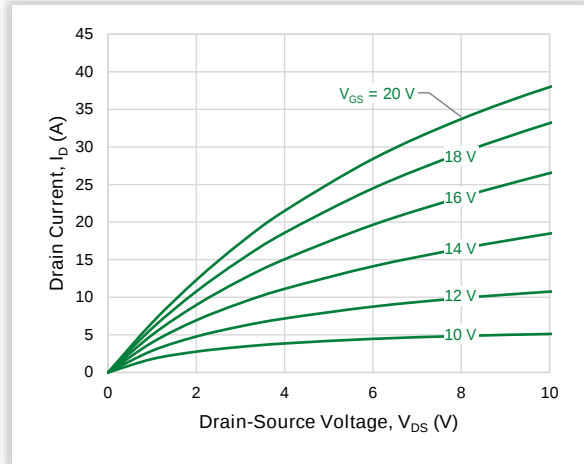
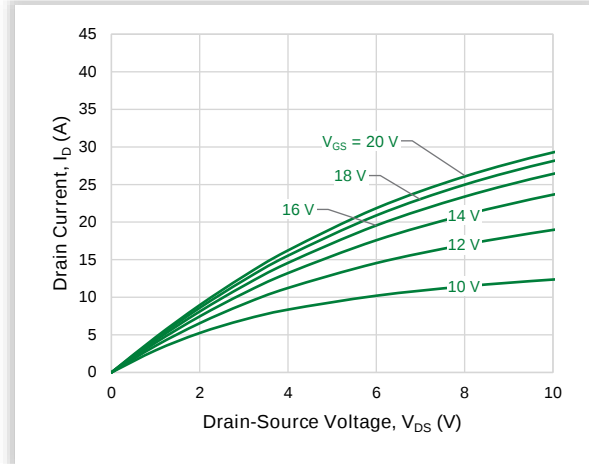
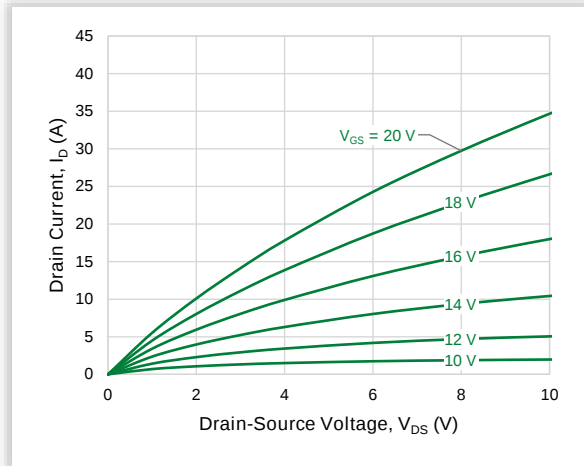
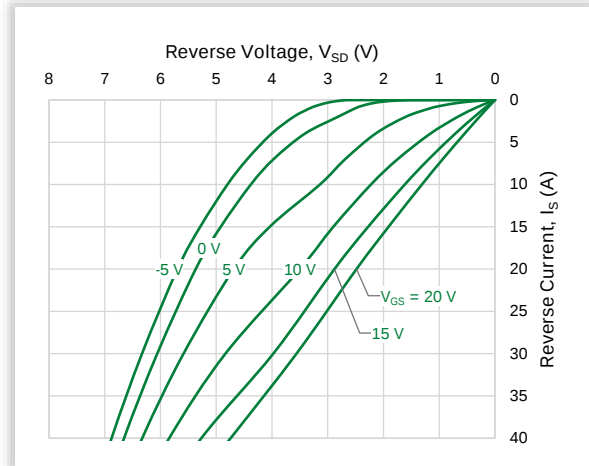
Figure 3. Typical Output Characteristics ( $T_J = 25^\circ\text{C}$ )Figure 4. Typical Output Characteristics ( $T_J = 175^\circ\text{C}$ )Figure 5. Typical Output Characteristics ( $T_J = -55^\circ\text{C}$ )Figure 6. Typical Reverse Conduction Characteristics ( $T_J = 25^\circ\text{C}$ )

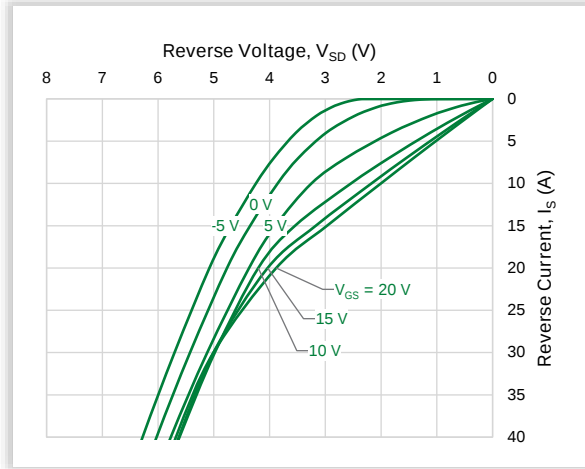
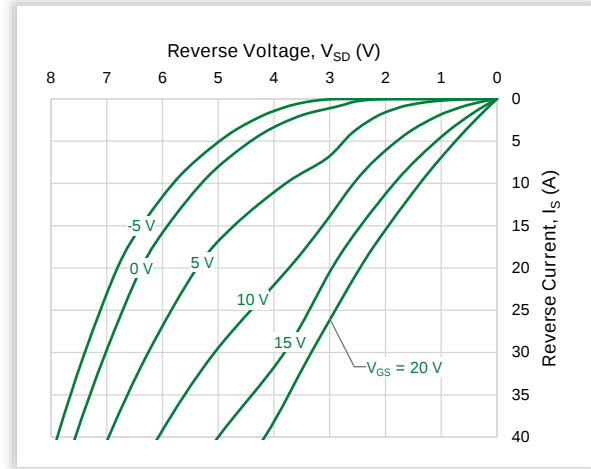
Figure 7. Typical Reverse Conduction Characteristics ( $T_J = 175\text{ }^{\circ}\text{C}$ )

Figure 8. Typical Reverse Conduction Characteristics ( $T_J = -55\text{ }^{\circ}\text{C}$ )


Figure 9. Transient Thermal Impedance

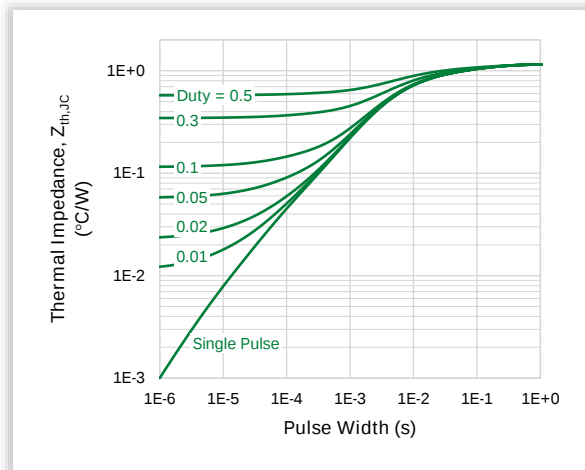
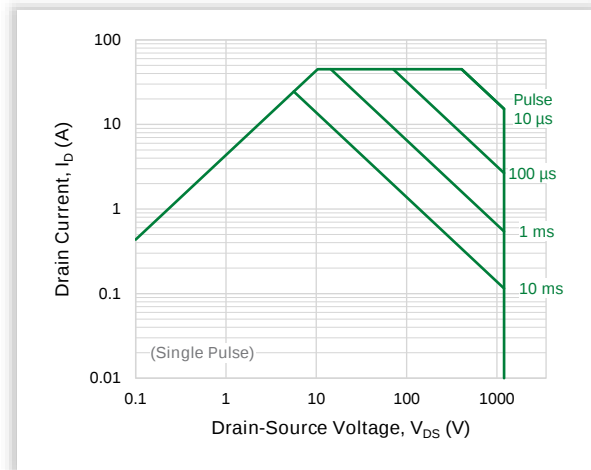

Figure 10. Maximum Safe Operating Area ( $T_C = 25\text{ }^{\circ}\text{C}$ )


Figure 11. On-resistance vs. Drain Current

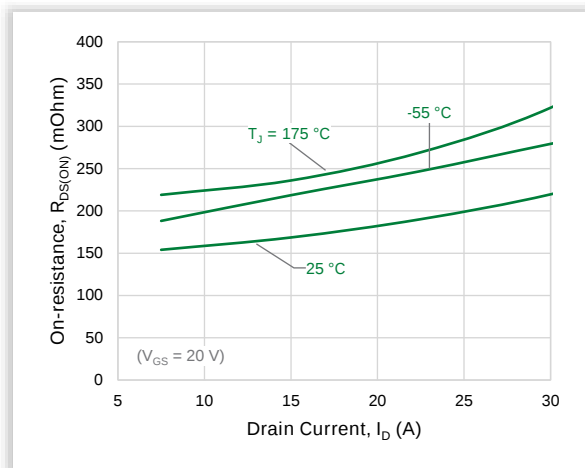


Figure 12. Normalized On-resistance vs. Junction Temperature

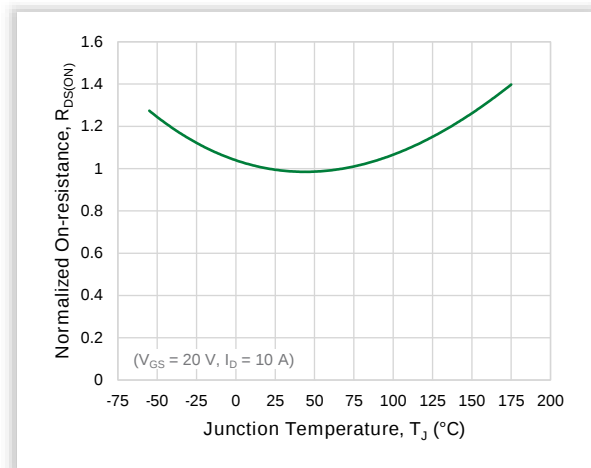


Figure 13. Typical On-resistance vs. Junction Temperature

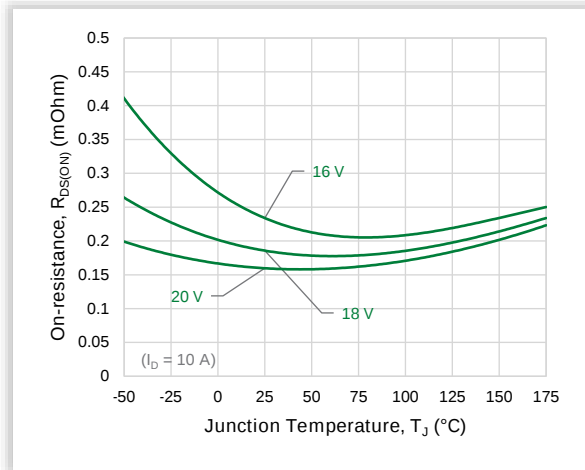


Figure 14. Typical Threshold Voltage

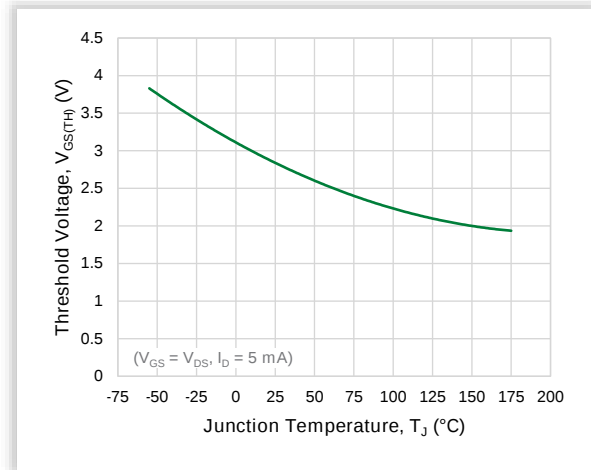


Figure 15. Typical Junction Capacitances up to 1000 V

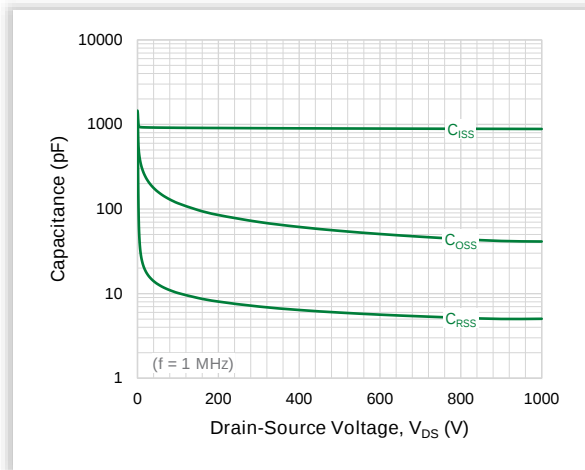


Figure 16. Typical Junction Capacitances up to 200 V

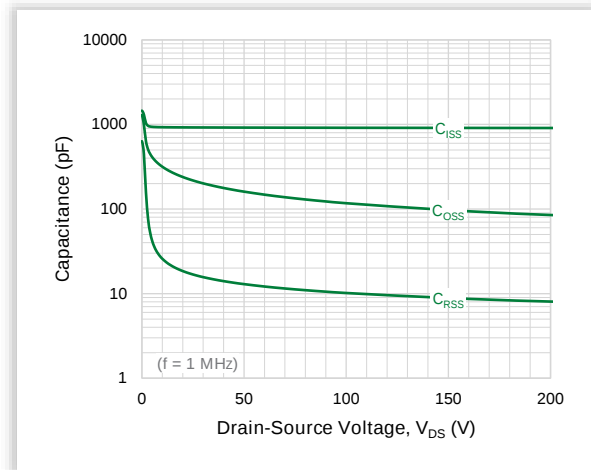


Figure 17. Typical C\_oss Stored Energy E\_oss

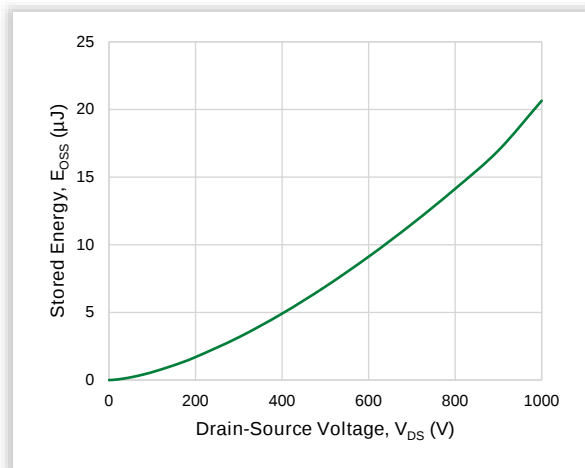


Figure 18. Typical Gate Charge

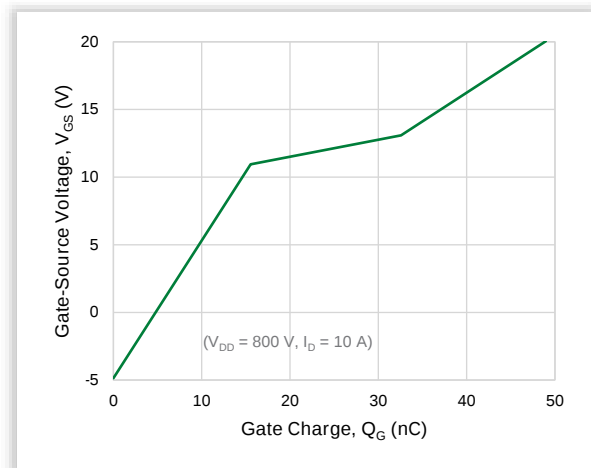


Figure 19. Typical Switching Energy vs. Drain Current

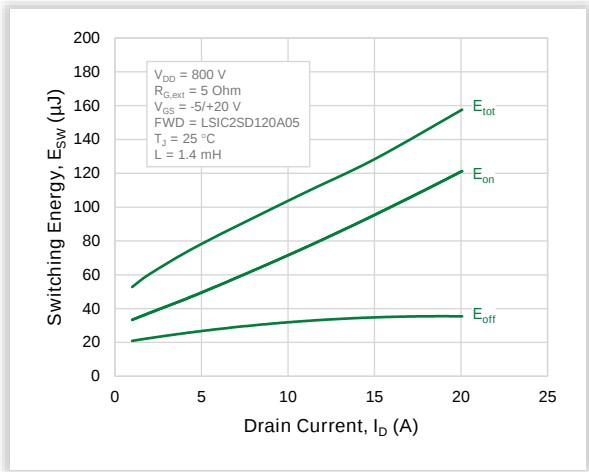


Figure 20. Typical Switching Energy vs. External Gate Resistance

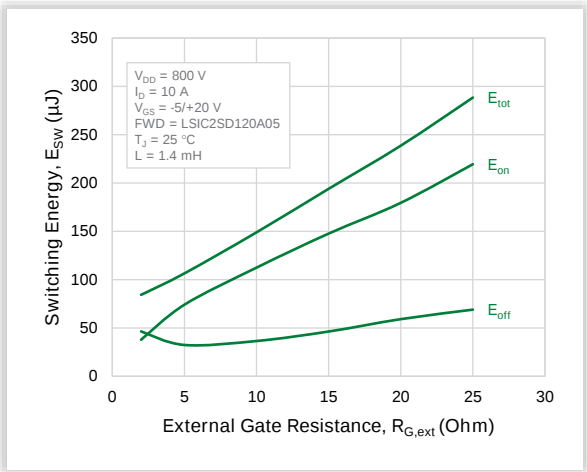
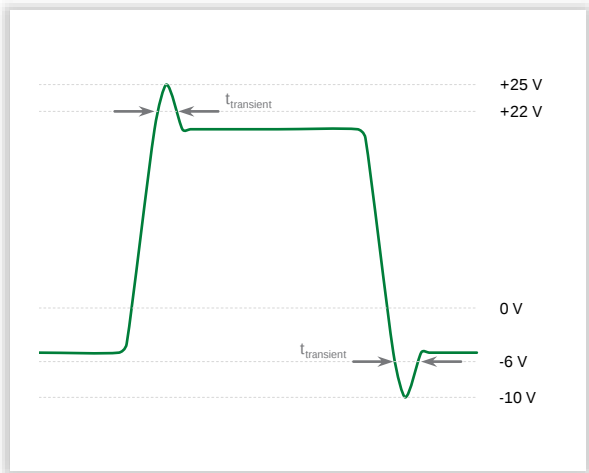
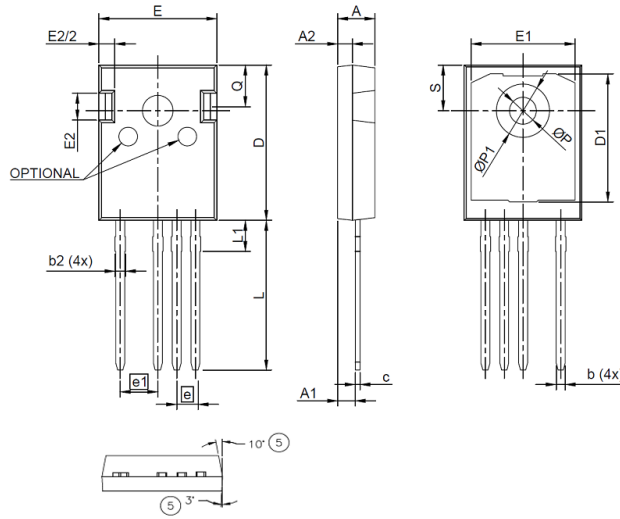


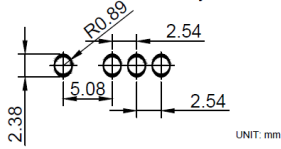
Figure 21.  $V_{GS}$  Waveform Definitions



## 6. Package Dimensions



### Recommended Hole Pattern Layout:

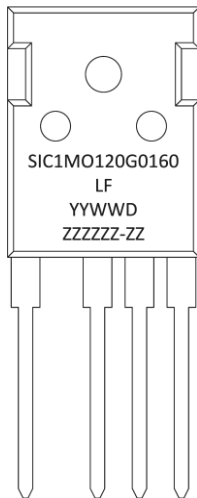


### Notes:

1. Dimensioning and tolerancing as per ASME Y14.5 – 2009.
2. Package outline in compliance with JEDEC Standard Var. Ad.
3. Dimension D, E do not include mold flash.
4. Mold draft angles excluded on the table.
5.  $\phi P$  to have a maximum draft angle of 1.7° to the top with a maximum hole diameter of 3.912 mm.

| Symbol    | Millimeters |       |
|-----------|-------------|-------|
|           | Min         | Max   |
| A         | 4.70        | 5.31  |
| A1        | 2.21        | 2.59  |
| A2        | 1.50        | 2.49  |
| b         | 0.99        | 1.40  |
| b2        | 1.65        | 2.39  |
| c         | 0.38        | 0.89  |
| D         | 20.80       | 21.46 |
| D1        | 13.08       | -     |
| D2        | 0.51        | 1.35  |
| E         | 15.49       | 16.26 |
| e         | 2.54 BSC    |       |
| e1        | 4.83        | 5.33  |
| E1        | 13.46       | -     |
| E2        | 3.56        | 4.06  |
| L         | 19.81       | 20.32 |
| L1        | -           | 4.50  |
| $\phi P$  | 3.56        | 3.66  |
| $\phi P1$ | 7.06        | 7.39  |
| Q         | 5.38        | 6.20  |
| S         | 6.17 BSC    |       |

## 7. Part Numbering and Marking

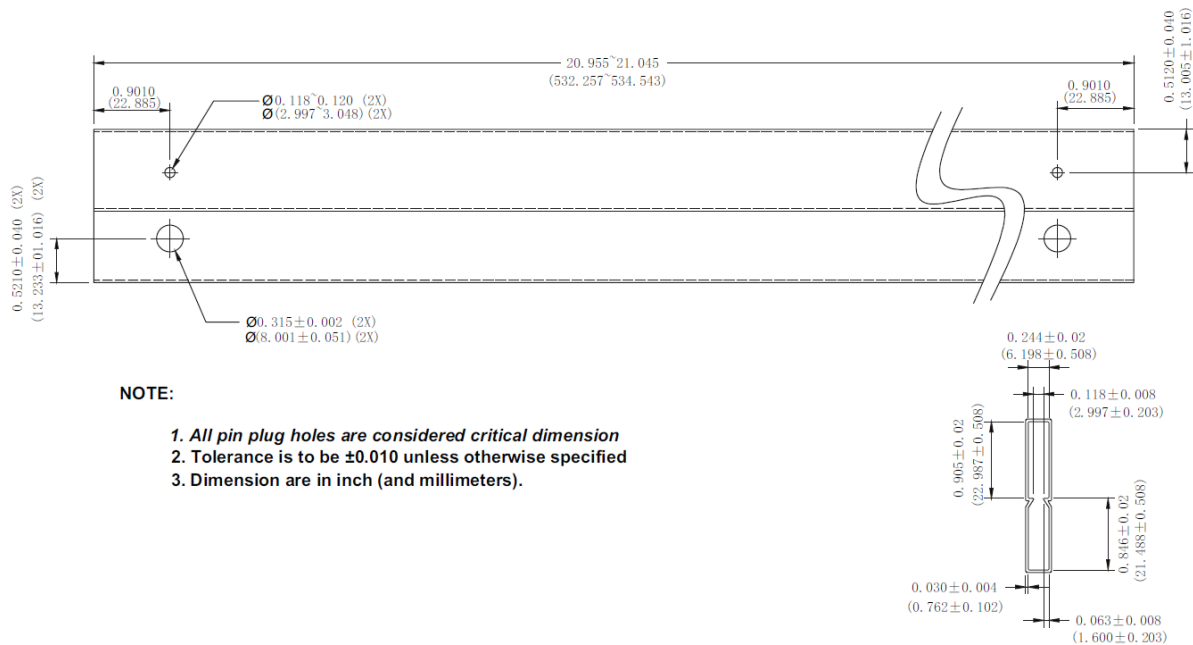


|           |                           |
|-----------|---------------------------|
| SiC       | = SiC                     |
| 1         | = Gen 1                   |
| MO        | = MOSFET                  |
| 120       | = Voltage Rating (1200 V) |
| G         | = TO-247-4L               |
| 0160      | = $R_{DS(ON)}$ (160 mOhm) |
| YY        | = Year                    |
| WW        | = Week                    |
| D         | = Special Code            |
| ZZZZZZ-ZZ | = Lot Number              |

## 8. Packing Options

| Part Number     | Marking        | Packing Mode     | M.O.Q. |
|-----------------|----------------|------------------|--------|
| LSIC1MO120G0160 | SIC1MO120G0160 | Tube<br>(30 pcs) | 450    |

## 9. Packing Specifications



For additional information please visit [www.Littelfuse.com/powersemi](http://www.Littelfuse.com/powersemi)

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